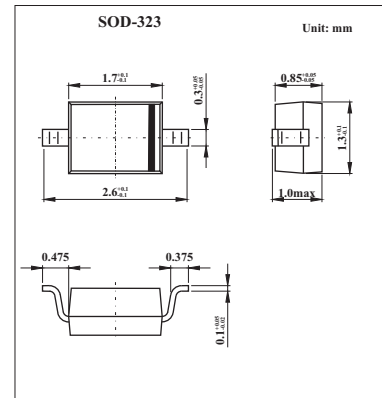


Surface Mount Zener Diode

MM3Z6V8S

■ Features

- Planar Die Construction
- Ultra-Small Surface Mount Package
- Ideally Suited for Automated Assembly Processes

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Power Dissipation (Note 1)	P_D	200	mW
Forward Voltage @ $I_F = 10\text{mA}$	V_F	0.9	V
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{\theta JA}$	625	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Note: 1. Part mounted on FR-4 PC board with recommended pad layout.

■ Electrical Characteristics @ $T_a = 25^\circ\text{C}$ unless otherwise specified

Type Number	Zener Voltage Range (Note 2)				Maximum Zener Impedance (Note 3)			Maximum Reverse Current (Note 2)		Typical Temperature Coefficient @ I_{ZT} $\text{mV}/^\circ\text{C}$	
	$V_Z @ I_{ZT}$			I_{ZT}	$Z_{ZT} @ I_{ZT}$	$Z_{ZK} @ I_{ZK}$	I_{ZK}	$I_R @ V_R$			
	Min (V)	Nom (V)	Max (V)	mA	Ω		mA	μA	V	Min	Max
MM3Z6V8S	6.4	6.8	7.2	5	15	160	0.5	2	4.0	1.2	4.5

Notes: 2. Short duration test pulse used to minimize self-heating effect.

3. $f = 1\text{kHz}$.

■ Marking

Marking	1X
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MM3Z6V8S

■ Typical Characteristics

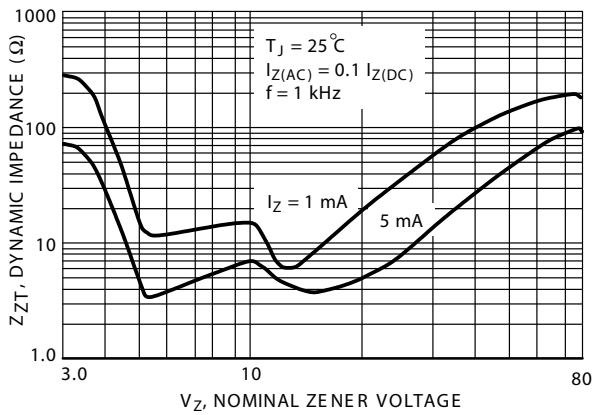


Fig.1 Effect of Zener Voltage on Zener Impedance

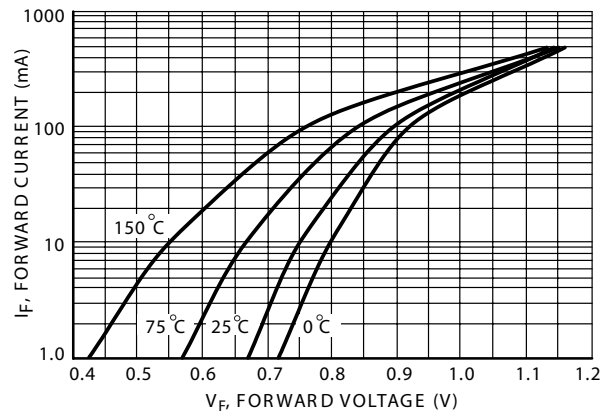


Fig.2 Typical Forward Voltage

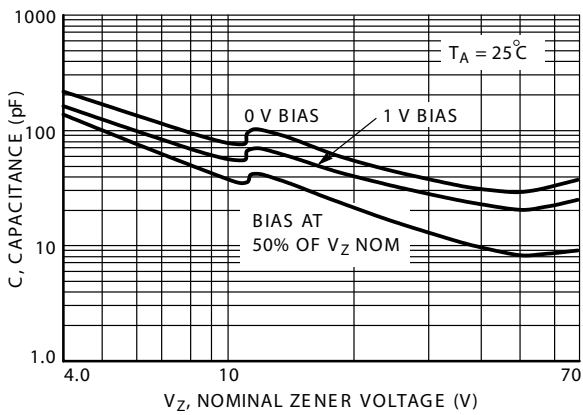


Fig.3 Typical Capacitance

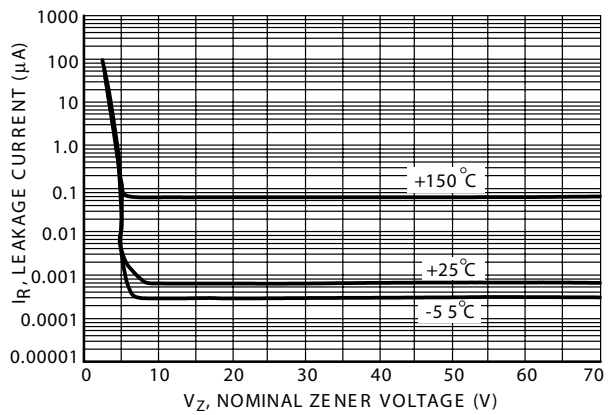


Fig.4 Typical Leakage Current

MM3Z6V8S

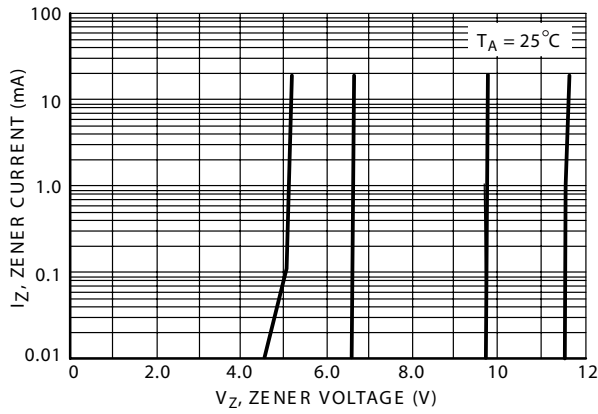


Fig.5 Zener Voltage versus Zener Current
(V_Z Up to 12 V)

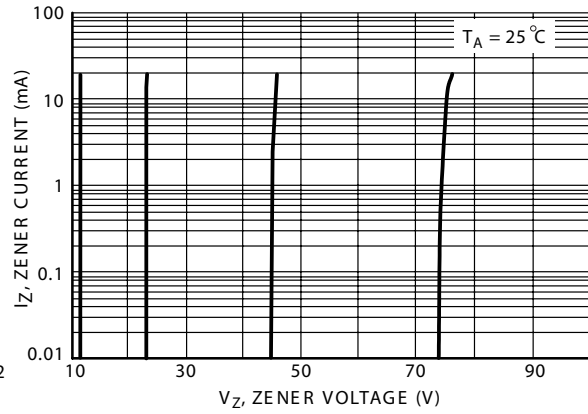


Fig.6 Zener Voltage versus Zener Current
(12 V to 75 V)

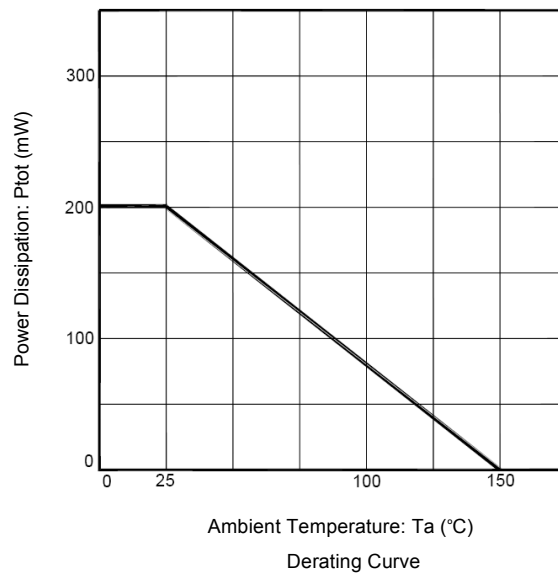


Fig.7 Power Dissipation VS Ambient Temperature